



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

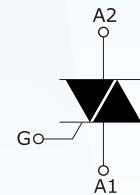
Product Specification

▶ Domestic Part Number	BTA24
▶ Overseas Part Number	BTA24
▶ Equivalent Part Number	BTA24

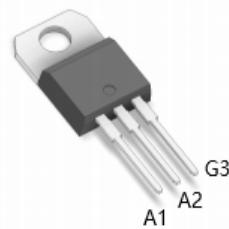


Product features and main applications:

NPNPN five-layer structure of silicon bidirectional devices; with independent intellectual property rights of single-sided digging technology, table glass passivation process; multi-layer metallized electrodes on the back; with high blocking voltage and high temperature stability.

**Mainly used in:**

vacuum cleaners, power tools and other motor speed controllers; solid state relays; heating controllers (temperature regulation); other phase control circuits.



TO-220A

Characteristics**Table 1. Absolute maximum ratings ($T_j = 25^\circ\text{C}$ unless otherwise stated)**

Symbol	Parameter name	value	Unit
$I_{T(\text{RMS})}$	RMS on-state current (full sine wave)	24	A
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C)	240	A
I^2t	I^2t value for fusing	288	A^2s
di/dt	Critical rate of rise of on-state current $IG = 2 \times IGT$, $tr \leq 100 \text{ ns}$	50	$\text{A}/\mu\text{s}$

V_{DRM}/V_{RRM}	Off state repetitive peak voltage Reverse repetitive peak voltage	$T_j=25^\circ C$		800	V
I_{GM}	Peak gate current	$t_p=20\mu s$	$T_j=150^\circ C$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_j=150^\circ C$	1	W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range		−40 to +150 −40 to +125		°C

Table 2. Electrical characteristics ($T_j = 25^\circ C$, unless otherwise specified)
--3quadrants

Symbol	Name and test conditions	Quadrant	Range	value		Unit	
I_{GT}	$V_D=12V \quad R_L=100 \Omega$	I II III	MAX	≤ 50		mA	
V_{GT}			MAX	1.5		V	
V_{GD}			MIN	0.2		V	
I_H	$I_T = 100 \text{ mA}$		MAX	80		mA	
I_L	$I_G = 1.2 \times I_{GT}$		MAX	I - III	80	mA	
				II	100		
dv/dt	VD = 67% VDRM, gate open, $T_j = 125^\circ C$	MIN	500			V/us	
$(dv/dt)_c$	Critical rise rate of commutation voltage $T_j = 150^\circ C$	MIN	10			V/us	

Table 3. Electrical characteristics ($T_j = 25^\circ\text{C}$, unless otherwise specified) -Standard Triac (4 quadrants)

Symbol	Name and test conditions	Quadrant	Range	value		Unit
I_{GT}	$V_D=12V$ $R_L=100\Omega$	I II III IV	MAX	I	III	mA
				≤ 50	≤ 120	
V_{GT}	$VD = VDRM$, $RL = 3.3 k\Omega$, $T_j = 125^\circ\text{C}$	IV	MAX	1.5		V
V_{GD}				0.2		
I_H	$I_T=500\text{mA}$		MAX	80		mA
I_L	$IG = 1.2 \times IGT$		MAX	80		mA
				100		
dv/dt	$VD = 67\% VDRM$, gate open, $T_j = 125^\circ\text{C}$		MIN	500		V/us
$(dv/dt)_c$	Critical rise rate of commutation voltage $T_j = 150^\circ\text{C}$		MIN	10		V/us

Static parameters

Symbol	Parameter name			value	Unit
V_{TM}	$I_{TM}= 50\text{A}$	$T_j=25^\circ\text{C}$	MAX	1.55	V
V_{T0}	threshold on-state voltage	$T_j=150^\circ\text{C}$	MAX	0.87	V
R_d	Dynamic resistance	$T_j=150^\circ\text{C}$	MAX	14.6	$\text{m}\Omega$
I_{DRM} I_{RRM}	$VDRM = VRM$		MAX	5	μA
				1	mA
$R_{th(j-c)}$	Junction to ambient	BTA	MAX	2.05	$^\circ\text{C}/\text{W}$

BTA24 characteristic curve

FIG.1: Maximum power dissipation versus RMS on-state current

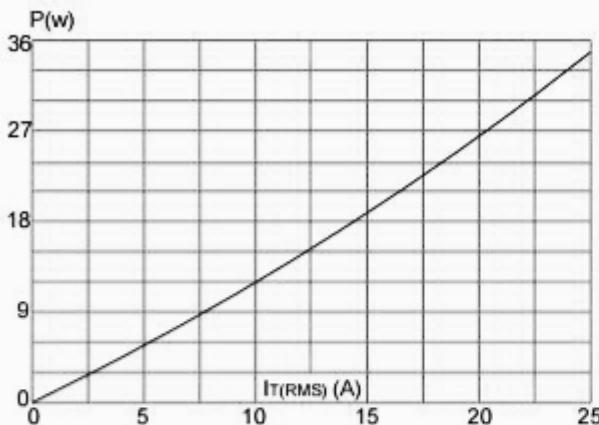


FIG.3: Surge peak on-state current versus number of cycles

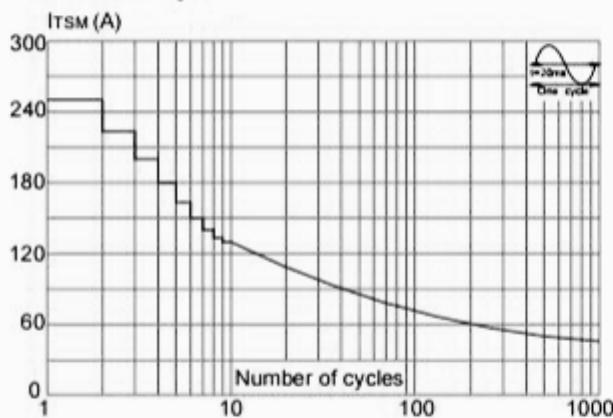


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 20\text{ms}$, and corresponding value of I^2t ($dI/dt < 50\text{A}/\mu\text{s}$)

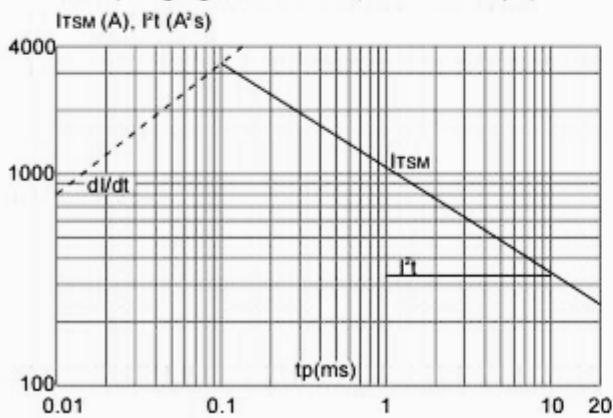


FIG.2: RMS on-state current versus case temperature

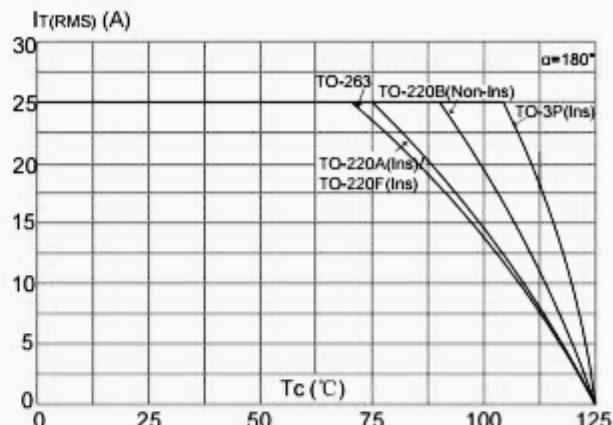


FIG.4: On-state characteristics (maximum values)

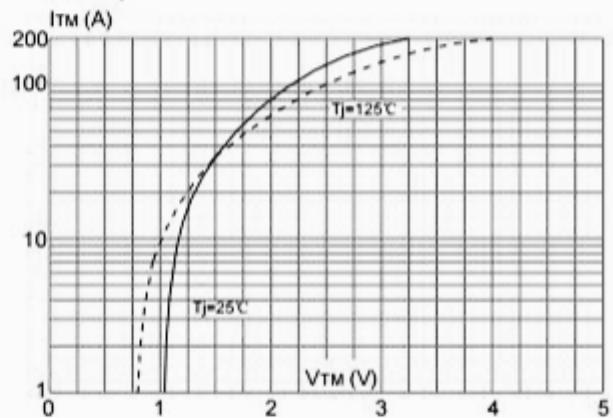
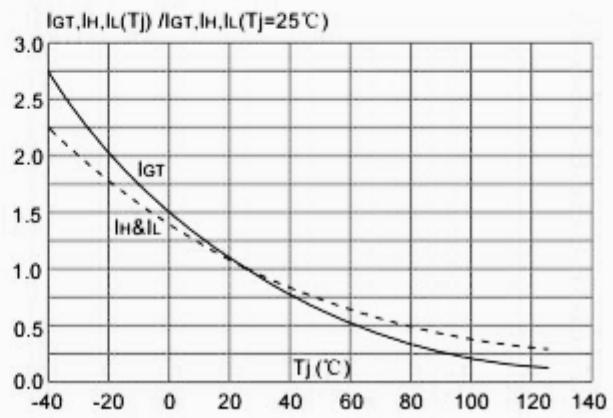
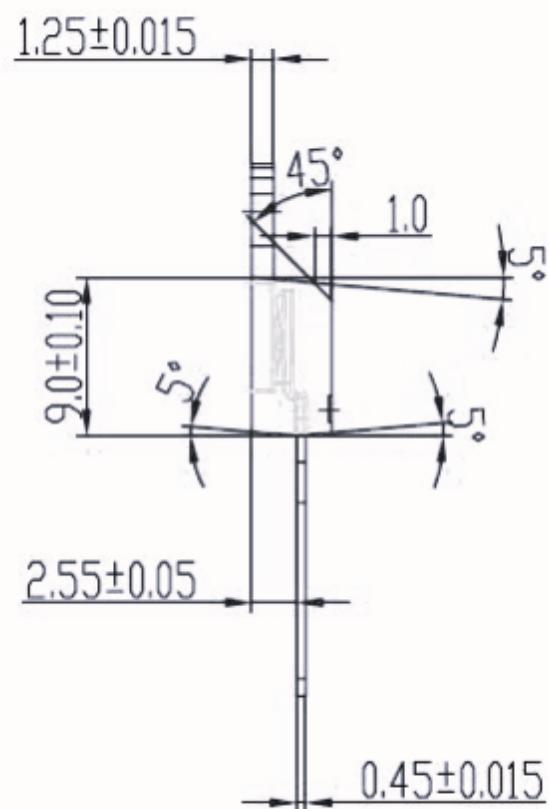
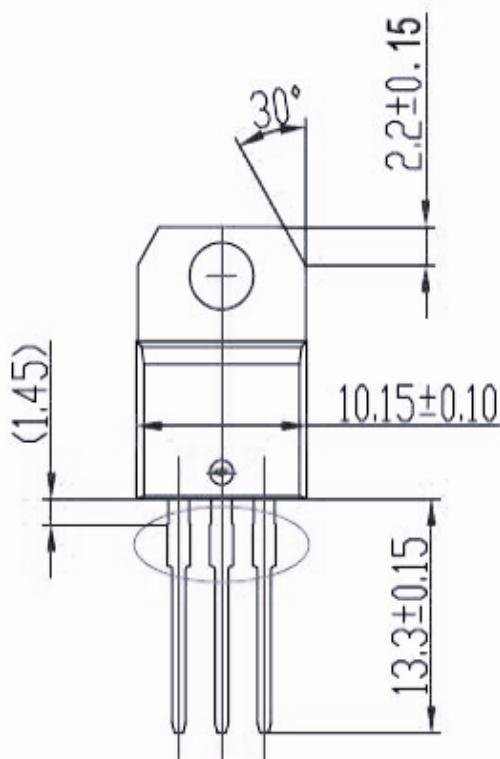


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



TO-220A Dimensional drawing:Unit: mm (± 0.1)

Ordering information

Order code	Package	Baseqty	Delivery mode
BTA24-600CRG	TO-220A	1000	Tube and box
BTA24-600BWRG	TO-220A	1000	Tube and box
BTA24-600CWRG	TO-220A	1000	Tube and box
BTA24-800CRG	TO-220A	1000	Tube and box
BTA24-800BRG	TO-220A	1000	Tube and box
BTA24-800BWRG	TO-220A	1000	Tube and box
BTA24-800CWRG	TO-220A	1000	Tube and box

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